6-Ball Wafer Level Chip Scale Package [WLCSP] (CB-6-7)
Dimensions shown in millimeters

- BALL A1 IDENTIFIER
- SEATING PLANE
- TOP VIEW (BALL SIDE DOWN)
- SIDE VIEW
- BOTTOM VIEW (BALL SIDE UP)

COPLANARITY 0.05

Dimensions in millimeters:
- Width: 0.945, 0.905, 0.865
- Height: 1.425, 1.385, 1.345
- Ball spacing: 0.40 BSC
- Ref: 0.80